

(99S0100-1)

COMPOSITION FOR SEALING A SEMICONDUCTOR DEVICE,
SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING
THE SAME

[X] is attached hereto.

[] was filed on

as United States Application No. or PCT International Application

No.

[] and was amended on

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365(b) of any foreign application(s) for patent or inventor's certificate, or 35 U.S.C. 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Japanese Patent Application No. 10-342715, filed December 2, 1998

Priority Claimed

Japanese Patent Application No. 11-253210, filed September 7, 1999

Priority Claimed

I hereby claim the benefit under 35 U.S.C. 119(e) of any United States provisional application(s) listed below.

I hereby claim the benefit under 35 U.S.C. 120 of any United States application(s) or 35 U.S.C. 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application or PCT International application in the manner provided by the first paragraph of 35 U.S.C. 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application.

I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: Douglas B. Henderson (Reg. No. 20,291), Ford F. Farabow, Jr. (Reg. No. 20,630), Arthur S. Garrett (Reg. No. 20,338), Donald R. Dunner (Reg. No. 19,073), Brian G. Brunsvold (Reg. No. 22,593), Tipton D. Jennings, IV (Reg. No. 20,645), Jerry D. Voight (Reg. No. 23,020), Laurence R. Hefter (Reg. No. 20,827), Kenneth E. Payne (Reg. No. 23,098), Herbert H. Mintz (Reg. No. 26,691), C. Larry O'Rourke (Reg. No. 26,014), Albert J. Santorelli (Reg. No. 22,610), Michael C. Elmer (Reg. No. 25,857), Richard H. Smith (Reg. No. 20,609), Stephen L. Peterson (Reg. No. 26,325), John M. Romary (Reg. No. 26,331), Bruce C. Zotter (Reg. No. 27,680), Dennis P. O'Reilly (Reg. No. 27,932), Allen M. Sokal (Reg. No. 26,695), Robert D. Bajefskey (Reg. No. 25,387), Richard L. Stroup (Reg. No. 28,478), David W. Hill (Reg. No. 28,220), Thomas L. Irving (Reg. No. 28,619), Charles E. Lipsey (Reg. No. 28,165), Thomas W. Winland (Reg. No. 27,605), Basil J. Lewris (Reg. No. 28,818), Martin I. Fuchs (Reg. No. 28,508), E. Robert Yoches (Reg. No. 30,120), Barry W. Graham (Reg. No. 29,924), Susan Haberma Griffen (Reg. No. 30,907), Richard B. Racine (Reg. No. 30,415), Thomas H. Jenkins (Reg. No. 30,857), Robert E. Converse, Jr. (Reg. No. 27,432), Clair X. Mullen, Jr. (Reg. No. 20,348), Christopher P. Foley (Reg. No. 31,354), John C. Paul (Reg. No. 30,413), David M. Kelly (Reg. No. 30,953), Kenneth J. Meyers (Reg. No. 25,146), Carol P. Einaudi (Reg. No. 32,220), Walter Y. Boyd, Jr. (Reg. No. 31,738), Steven M. Anzalone (Reg. No. 32,095), Jean B. Fordis (Reg. No. 32,984), Barbara C. McCurdy (Reg. No. 32,120), James K. Hammond (Reg. No. 31,964), Richard V. Burgujian (Reg. No. 31,744), J. Michael Jakes (Reg. No. 32,824), Thomas W. Banks (Reg. No. 32,719), M. Paul Barker (Reg. No. 32,013), Bryan C. Diner (Reg. No. 32,409), Christopher P. Isaac (Reg. No. 32,616), Andrew Chanh Sonu (Reg. No. 33,457), Dirk D. Thomas (Reg. No. 32,600), David S. Forman (Reg. No. 33,694), Vincent P. Kovalick (Reg. No. 32,867), James W. Edmondson (Reg. No. 33,871), Michael R. McGurk (Reg. No. 32,045), Joann M. Neth (Reg. No. 36,363), Gerson S. Panitch (Reg. No. 33,751), Cheri M. Taylor (Reg. No. 33,216) and Charles E. Van Horn (Reg. No. 40,266), each of whose address is 1300 I Street, N.W., Washington, D.C. 20005-3315, or any one of them, and request that correspondence be directed to Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P., 1300 I Street, N.W., Washington, D.C. 20005-3315.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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